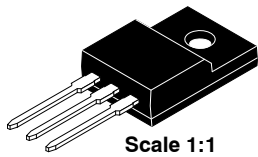


MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

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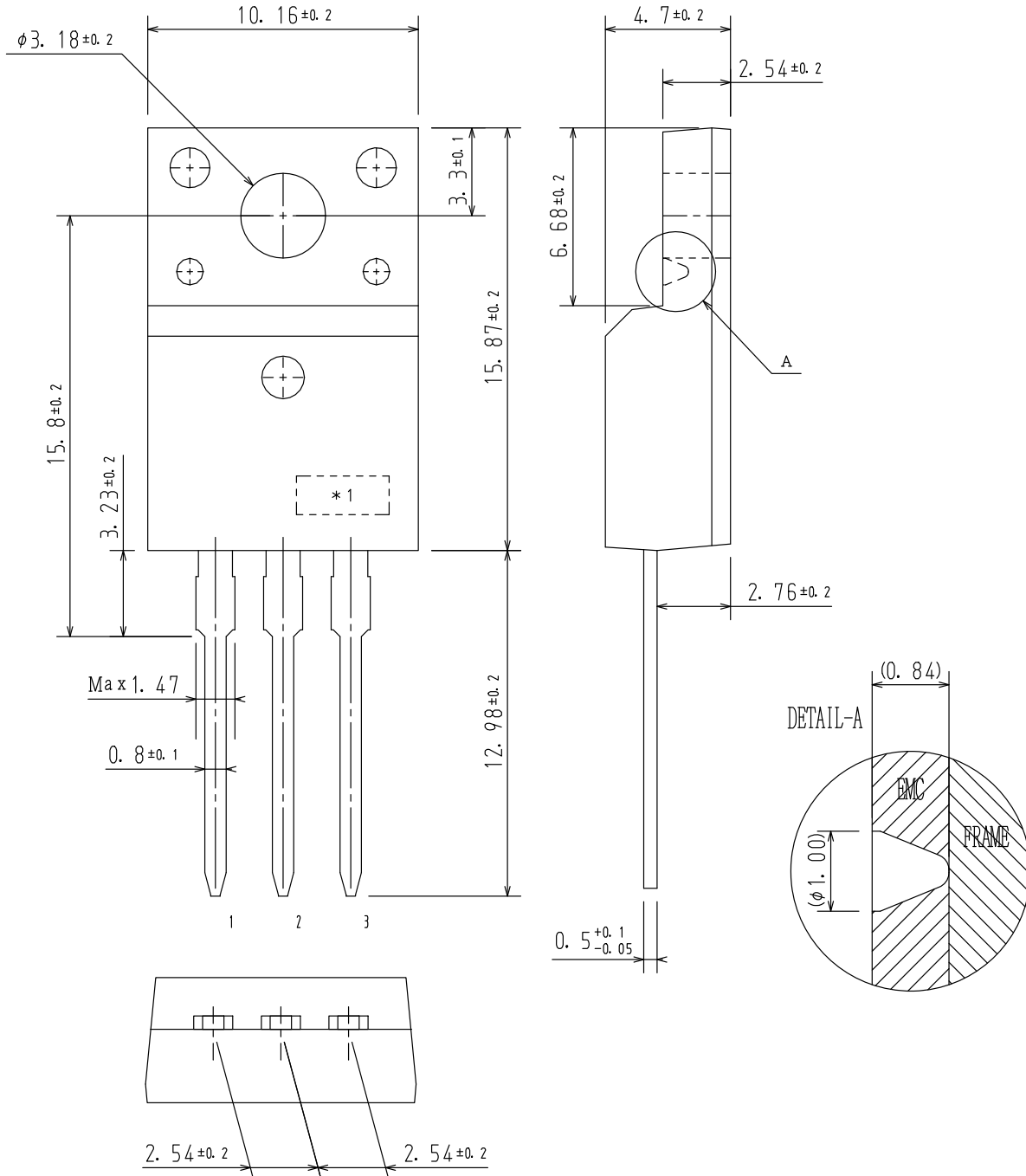
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Scale 1:1

TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT ISSUE A

DATE 12 NOV 2013



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DESCRIPTION:	TO-220 FULLPACK, 3-LEAD / TO-220F-3SG	PAGE 1 OF 1

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